

## SN54LVC02A, SN74LVC02A **QUADRUPLE 2-INPUT POSITIVE-NOR GATES**

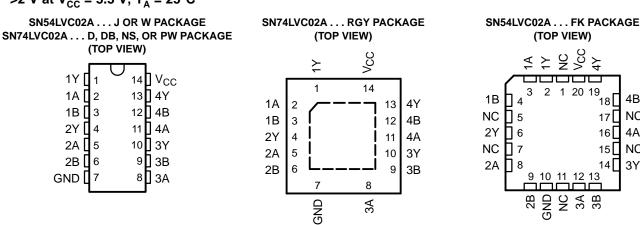
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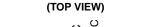
### FEATURES

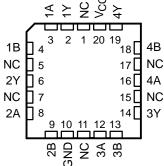
- Operate From 1.65 V to 3.6 V
- Specified From -40°C to 85°C, -40°C to 125°C, and -55°C to 125°C
- Inputs Accept Voltages to 5.5 V
- Max t<sub>nd</sub> of 4.4 ns at 3.3 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at  $V_{CC}$  = 3.3 V, T<sub>A</sub> = 25°C
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot) >2 V at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C



- **ESD Protection Exceeds JESD 22** 
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)







NC - No internal connection

## DESCRIPTION/ORDERING INFORMATION

The SN54LVC02A quadruple 2-input positive-NOR gate is designed for 2.7-V to 3.6-V V<sub>CC</sub> operation, and the SN74LVC02A quadruple 2-input positive-NOR gate is designed for 1.65-V to 3.6-V V<sub>CC</sub> operation.

The LVC02A devices perform the Boolean function  $Y = \overline{A + B}$  or  $Y = \overline{A \cdot B}$  in positive logic.

| T <sub>A</sub> | PA         | CKAGE <sup>(1)</sup> | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------|----------------------|-----------------------|------------------|
| –40°C to 85°C  | QFN – RGY  | Reel of 1000         | SN74LVC02ARGYR        | LC02A            |
|                |            | Tube of 50           | SN74LVC02AD           |                  |
| -40°C to 125°C | SOIC – D   | Reel of 2500         | SN74LVC02ADR          | LVC02A           |
|                |            | Reel of 250          | SN74LVC02ADT          |                  |
|                | SOP – NS   | Reel of 2000         | SN74LVC02ANSR         | LVC02A           |
| -40 C 10 125 C | SSOP – DB  | Reel of 2000         | SN74LVC02ADBR         | LC02A            |
|                |            | Tube of 90           | SN74LVC02APW          |                  |
|                | TSSOP – PW | Reel of 2000         | SN74LVC02APWR         | LC02A            |
|                |            | Reel of 250          | SN74LVC02APWT         |                  |
|                | CDIP – J   | Tube of 25           | SNJ54LVC02AJ          | SNJ54LVC02AJ     |
| –55°C to 125°C | CFP – W    | Tube of 150          | SNJ54LVC02AW          | SNJ54LVC02AW     |
|                | LCCC – FK  | Tube of 55           | SNJ54LVC02AFK         | SNJ54LVC02AFK    |

#### **ORDERING INFORMATION**

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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## SN54LVC02A, SN74LVC02A QUADRUPLE 2-INPUT POSITIVE-NOR GATES

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## **DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

#### **FUNCTION TABLE** (EACH GATE)

| INP | INPUTS |   |  |  |  |  |
|-----|--------|---|--|--|--|--|
| Α   | В      | Y |  |  |  |  |
| Н   | Х      | L |  |  |  |  |
| Х   | Н      | L |  |  |  |  |
| L   | L      | Н |  |  |  |  |

#### LOGIC DIAGRAM, EACH GATE (POSITIVE LOGIC)



### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |  |   | MIN  | MAX                   | UNIT |
|------------------|--|---|------|-----------------------|------|
| V <sub>CC</sub>  | Supply voltage range                       |   | -0.5 | 6.5                   | V    |
| VI               | Input voltage range <sup>(2)</sup>         |   | -0.5 | 6.5                   | V    |
| Vo               | Output voltage range <sup>(2)(3)</sup>     |   | -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>IK</sub>  | Input clamp current                        | V <sub>1</sub> < 0                              |      | -50                   | mA   |
| I <sub>OK</sub>  | Output clamp current                       | V <sub>O</sub> < 0                              |      | -50                   | mA   |
| I <sub>O</sub>   | Continuous output current                  |   |      | ±50                   | mA   |
|                  | Continuous current through $V_{CC}$ or GND |   |      | ±100                  | mA   |
|                  |  | D package <sup>(4)</sup>                        |      | 86                    |      |
|                  |  | DB package <sup>(4)</sup>                       |      | 96                    |      |
| $\theta_{JA}$    | Package thermal impedance                  | NS package <sup>(4)</sup>                       |      | 76                    | °C/W |
|                  |  | PW package <sup>(4)</sup>                       |      | 113                   |      |
|                  |  | RGY package <sup>(5)</sup>                      |      | 47                    |      |
| T <sub>stg</sub> | Storage temperature range                  |   | -65  | 150                   | °C   |
| P <sub>tot</sub> | Power dissipation                          | $T_A = -40^{\circ}C$ to $125^{\circ}C^{(6)(7)}$ |      | 500                   | mW   |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. (2)

(3) The value of V<sub>CC</sub> is provided in the recommended operating conditions table.

The package thermal impedance is calculated in accordance with JESD 51-7. (4)

(5) The package thermal impedance is calculated in accordance with JESD 51-5.

(6)

For the D package: above 70°C, the value of P<sub>tot</sub> derates linearly with 8 mW/K. For the DB, NS, and PW packages: above 60°C, the value of P<sub>tot</sub> derates linearly with 5.5 mW/K. (7)

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### **Recommended Operating Conditions**<sup>(1)</sup>

|                 |                           |  | SN54LV   | C02A            |          |  |
|-----------------|---------------------------|--|----------|-----------------|----------|--|
|                 |                           |  | –55°C to | 125°C           | UNIT     |  |
|                 |                           |  | MIN      | MAX             | <u> </u> |  |
| V               | Supply voltage            | Operating                                  | 2        | 3.6             | V        |  |
| V <sub>CC</sub> | Supply voltage            | Data retention only                        | 1.5      |                 | v        |  |
| VIH             | High-level input voltage  | V <sub>CC</sub> = 2.7 V to 3.6 V           | 2        |                 | V        |  |
| V <sub>IL</sub> | Low-level input voltage   | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ |          | 0.8             | V        |  |
| VI              | Input voltage             |  | 0        | 5.5             | V        |  |
| Vo              | Output voltage            |  | 0        | V <sub>CC</sub> | V        |  |
|                 |                           | $V_{CC} = 2.7 V$                           |          | -12             |          |  |
| I <sub>OH</sub> | High-level output current | $V_{CC} = 3 V$                             |          | -24             | mA       |  |
|                 |                           | $V_{CC} = 2.7 V$                           |          | 12              | ~ ^      |  |
| I <sub>OL</sub> | Low-level output current  | $V_{CC} = 3 V$                             |          | 24              | mA       |  |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

### **Recommended Operating Conditions**<sup>(1)</sup>

|                 |                             |  |                      |                      | SN74L                | VC02A                |                      |                      |      |
|-----------------|-----------------------------|--|----------------------|----------------------|----------------------|----------------------|----------------------|----------------------|------|
|                 |                             |  | T <sub>A</sub> = 2   | 25°C                 | -40°C                | to 85°C              | –40°C to             | o 125°C              | UNIT |
|                 |                             |  | MIN                  | MAX                  | MIN                  | MAX                  | MIN                  | MAX                  |      |
| V               | Supply voltogo              | Operating                                  | 1.65                 | 3.6                  | 1.65                 | 3.6                  | 1.65                 | 3.6                  | V    |
| V <sub>CC</sub> | Supply voltage              | Data retention only                        | 1.5                  |                      | 1.5                  |                      | 1.5                  |                      | v    |
|                 |                             | $V_{CC}$ = 1.65 V to 1.95 V                | $0.65 \times V_{CC}$ |                      | $0.65 \times V_{CC}$ |                      | $0.65 \times V_{CC}$ |                      |      |
| VIH             | High-level<br>input voltage | $V_{CC}$ = 2.3 V to 2.7 V                  | 1.7                  |                      | 1.7                  |                      | 1.7                  |                      | V    |
|                 | input voltage               | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2                    |                      | 2                    |                      | 2                    |                      |      |
|                 |                             | $V_{CC}$ = 1.65 V to 1.95 V                |                      | $0.35 \times V_{CC}$ |                      | $0.35 \times V_{CC}$ |                      | $0.35 \times V_{CC}$ |      |
| VIL             | Low-level<br>input voltage  | $V_{CC}$ = 2.3 V to 2.7 V                  |                      | 0.7                  |                      | 0.7                  |                      | 0.7                  | V    |
|                 | input voltage               | V <sub>CC</sub> = 2.7 V to 3.6 V           |                      | 0.8                  |                      | 0.8                  |                      | 0.8                  |      |
| VI              | Input voltage               |  | 0                    | 5.5                  | 0                    | 5.5                  | 0                    | 5.5                  | V    |
| Vo              | Output voltage              |  | 0                    | V <sub>CC</sub>      | 0                    | V <sub>CC</sub>      | 0                    | V <sub>CC</sub>      | V    |
|                 |                             | V <sub>CC</sub> = 1.65 V                   |                      | -4                   |                      | -4                   |                      | -4                   |      |
|                 | High-level                  | V <sub>CC</sub> = 2.3 V                    |                      | -8                   |                      | -8                   |                      | -8                   | 0    |
| I <sub>OH</sub> | output current              | V <sub>CC</sub> = 2.7 V                    |                      | -12                  |                      | -12                  |                      | -12                  | mA   |
|                 |                             | V <sub>CC</sub> = 3 V                      |                      | -24                  |                      | -24                  |                      | -24                  |      |
|                 |                             | V <sub>CC</sub> = 1.65 V                   |                      | 4                    |                      | 4                    |                      | 4                    |      |
|                 | Low-level                   | V <sub>CC</sub> = 2.3 V                    |                      | 8                    |                      | 8                    |                      | 8                    | A    |
| I <sub>OL</sub> | output current              | V <sub>CC</sub> = 2.7 V                    |                      | 12                   |                      | 12                   |                      | 12                   | mA   |
| I               |                             | $V_{CC} = 3 V$                             |                      | 24                   |                      | 24                   |                      | 24                   |      |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# SN54LVC02A, SN74LVC02A QUADRUPLE 2-INPUT POSITIVE-NOR GATES

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#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

|                 |  |                 | SN54           | LVC02A           |     |
|-----------------|--|-----------------|----------------|------------------|-----|
| PARAMETER       | TEST CONDITIONS  | V <sub>cc</sub> | –55°C          | UNIT             |     |
|                 |  |                 | MIN            | TYP MAX          |     |
|                 | I <sub>OH</sub> = -100 μA                                      | 2.7 V to 3.6 V  | $V_{CC} - 0.2$ |                  |     |
| V               | L = 12 mA  | 2.7 V           | 2.2            |                  | v   |
| V <sub>OH</sub> | $I_{OH} = -12 \text{ mA}$                                      | 3 V             | 2.4            |                  | V   |
|                 | $I_{OH} = -24 \text{ mA}$                                      | 3 V             | 2.2            |                  |     |
|                 | I <sub>OL</sub> = 100 μA                                       | 2.7 V to 3.6 V  |                | 0.2              | 1   |
| V <sub>OL</sub> | I <sub>OL</sub> = 12 mA  | 2.7 V           |                | 0.4              | · V |
|                 | I <sub>OL</sub> = 24 mA  | 3 V             |                | 0.55             |     |
| I <sub>I</sub>  | $V_1 = 5.5 \text{ V or GND}$                                   | 3.6 V           |                | ±ť               | μΑ  |
| I <sub>CC</sub> | $V_{I} = V_{CC} \text{ or } \text{GND}, I_{O} = 0$             | 3.6 V           |                | 1(               | μA  |
| $\Delta I_{CC}$ | One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND | 2.7 V to 3.6 V  |                | 500              | μA  |
| C <sub>i</sub>  | $V_1 = V_{CC}$ or GND  | 3.3 V           |                | 5 <sup>(1)</sup> | pF  |

(1)  $T_A = 25^{\circ}C$ 

#### **Electrical Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

|                 |   |                 |                  |        | S    | SN74LVC02A            |      |                |      |      |
|-----------------|---|-----------------|------------------|--------|------|-----------------------|------|----------------|------|------|
| PAR-<br>AMETER  | TEST CONDITIONS   | V <sub>cc</sub> | T <sub>A</sub> = | = 25°C |      | –40°C to 8            | 35°C | –40°C to 125°C |      | UNIT |
|                 |   |                 | MIN              | TYP    | MAX  | MIN                   | MAX  | MIN            | MAX  |      |
|                 | I <sub>OH</sub> = −100 μA                                       | 1.65 V to 3.6 V | $V_{CC} - 0.2$   |        |      | V <sub>CC</sub> – 0.2 |      | $V_{CC} - 0.3$ |      |      |
|                 | $I_{OH} = -4 \text{ mA}$  | 1.65 V          | 1.29             |        |      | 1.2                   |      | 1.05           |      |      |
| V               | I <sub>OH</sub> = -8 mA   | 2.3 V           | 1.9              |        |      | 1.7                   |      | 1.55           |      | V    |
| V <sub>OH</sub> | 1 10 m 4  | 2.7 V           | 2.2              |        |      | 2.2                   |      | 2.05           |      | v    |
|                 | I <sub>OH</sub> = -12 mA  | 3 V             | 2.4              |        |      | 2.4                   |      | 2.25           |      |      |
|                 | I <sub>OH</sub> = -24 mA  | 3 V             | 2.3              |        |      | 2.2                   |      | 2              |      |      |
|                 | I <sub>OL</sub> = 100 μA  | 1.65 V to 3.6 V |                  |        | 0.1  |                       | 0.2  |                | 0.3  |      |
|                 | $I_{OL} = 4 \text{ mA}$   | 1.65 V          |                  |        | 0.24 |                       | 0.45 |                | 0.6  |      |
| V <sub>OL</sub> | I <sub>OL</sub> = 8 mA  | 2.3 V           |                  |        | 0.3  |                       | 0.7  |                | 0.75 | V    |
|                 | I <sub>OL</sub> = 12 mA   | 2.7 V           |                  |        | 0.4  |                       | 0.4  |                | 0.6  |      |
|                 | I <sub>OL</sub> = 24 mA   | 3 V             |                  |        | 0.55 |                       | 0.55 |                | 0.8  |      |
| l <sub>l</sub>  | $V_{I} = 5.5 V \text{ or GND}$                                  | 3.6 V           |                  |        | ±1   |                       | ±5   |                | ±20  | μA   |
| I <sub>CC</sub> | $V_{I} = V_{CC}$ or GND, $I_{O} = 0$                            | 3.6 V           |                  |        | 1    |                       | 10   |                | 40   | μA   |
| $\Delta I_{CC}$ | One input at $V_{CC} - 0.6 V$ , Other inputs at $V_{CC}$ or GND | 2.7 V to 3.6 V  |                  |        | 500  |                       | 500  |                | 5000 | μΑ   |
| Ci              | $V_{I} = V_{CC}$ or GND   | 3.3 V           |                  | 5      |      |                       |      |                |      | pF   |

### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|           |                 |                |                                   | SN54LV   |      |    |
|-----------|-----------------|----------------|-----------------------------------|----------|------|----|
| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub>                   | −55°C to | UNIT |    |
|           | (               | (001101)       |                                   | MIN      | MAX  |    |
| +         | A or B          | ×              | 2.7 V                             |          | 5.4  | 20 |
| ۲pd       | AOIB            | F              | $3.3 \text{ V} \pm 0.3 \text{ V}$ | 1        | 4.4  | ns |

### **Switching Characteristics**

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                    |                 |                |                 |               |                     | SI    | N74LVC0  | 2A     |          |       |      |       |   |       |   |   |   |       |   |   |     |   |     |   |   |
|--------------------|-----------------|----------------|-----------------|---------------|---------------------|-------|----------|--------|----------|-------|------|-------|---|-------|---|---|---|-------|---|---|-----|---|-----|---|---|
| PARAMETER          | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | T,            | <sub>λ</sub> = 25°C | ;     | –40°C te | o 85°C | -40°C to | 125°C | UNIT |       |   |       |   |   |   |       |   |   |     |   |     |   |   |
|                    | (               | (001101)       |                 | MIN           | TYP                 | MAX   | MIN      | MAX    | MIN      | MAX   |      |       |   |       |   |   |   |       |   |   |     |   |     |   |   |
|                    |                 |                | 1.8 V ± 0.15 V  | 1             | 3.8                 | 8.4   | 1        | 8.9    | 1        | 10.4  |      |       |   |       |   |   |   |       |   |   |     |   |     |   |   |
|                    | A or B          | Y              | Y               | 2.5 V ± 0.2 V | 1                   | 2.9   | 6.9      | 1      | 7.4      | 1     | 9.5  | ~~    |   |       |   |   |   |       |   |   |     |   |     |   |   |
| t <sub>pd</sub>    | AUD             |                |                 | Т             | 1                   | г<br> | I        | I      | Т        | Т     | I    | т<br> | I | т<br> | ř | Ŷ | Y | 2.7 V | 1 | 3 | 5.2 | 1 | 5.4 | 1 | 7 |
|                    |                 |                | 3.3 V ± 0.3 V   | 1             | 3.6                 | 4.2   | 1        | 4.4    | 1        | 5.5   |      |       |   |       |   |   |   |       |   |   |     |   |     |   |   |
| t <sub>sk(o)</sub> |                 |                | 3.3 V ± 0.3 V   |               |                     |       |          | 1      |          | 1.5   | ns   |       |   |       |   |   |   |       |   |   |     |   |     |   |   |

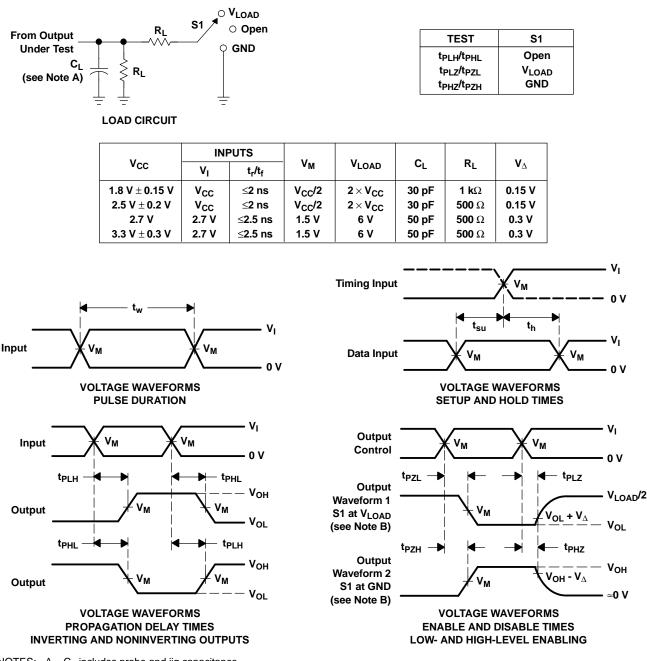
## **Operating Characteristics**

 $T_A = 25^{\circ}C$ 

|                 | PARAMETER                              | TEST<br>CONDITIONS | V <sub>cc</sub> | TYP | UNIT |
|-----------------|--|--------------------|-----------------|-----|------|
|                 |  |                    | 1.8 V           | 7.5 |      |
| C <sub>pd</sub> | Power dissipation capacitance per gate | f = 10 MHz         | 2.5 V           | 8.5 | pF   |
|                 |  |                    | 3.3 V           | 9.5 |      |

## SN54LVC02A, SN74LVC02A QUADRUPLE 2-INPUT POSITIVE-NOR GATES

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PARAMETER MEASUREMENT INFORMATION

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- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z\_O = 50  $\Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

#### Figure 1. Load Circuit and Voltage Waveforms



6-Feb-2020

### PACKAGING INFORMATION

| Orderable Device | Status | Package Type |         | Pins | •    | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp       | Op Temp (°C) | Device Marking                           | Samples |
|------------------|--------|--------------|---------|------|------|----------------------------|------------------|---------------------|--------------|--|---------|
|                  | (1)    |              | Drawing |      | Qty  | (2)                        | (6)              | (3)                 |              | (4/5)                                    |         |
| 5962-9760401Q2A  | ACTIVE | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type  | -55 to 125   | 5962-<br>9760401Q2A<br>SNJ54LVC<br>02AFK | Samples |
| 5962-9760401QCA  | ACTIVE | CDIP         | J       | 14   | 1    | TBD                        | Call TI          | N / A for Pkg Type  | -55 to 125   | 5962-9760401QC<br>A<br>SNJ54LVC02AJ      | Samples |
| 5962-9760401QDA  | ACTIVE | CFP          | W       | 14   | 1    | TBD                        | Call TI          | N / A for Pkg Type  | -55 to 125   | 5962-9760401QD<br>A<br>SNJ54LVC02AW      | Samples |
| SN74LVC02AD      | ACTIVE | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LVC02A                                   | Samples |
| SN74LVC02ADBR    | ACTIVE | SSOP         | DB      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02ADR     | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LVC02A                                   | Samples |
| SN74LVC02ADRG4   | ACTIVE | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LVC02A                                   | Samples |
| SN74LVC02ANSR    | ACTIVE | SO           | NS      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LVC02A                                   | Samples |
| SN74LVC02APW     | ACTIVE | TSSOP        | PW      | 14   | 90   | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02APWE4   | ACTIVE | TSSOP        | PW      | 14   | 90   | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02APWR    | ACTIVE | TSSOP        | PW      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02APWT    | ACTIVE | TSSOP        | PW      | 14   | 250  | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02APWTG4  | ACTIVE | TSSOP        | PW      | 14   | 250  | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM  | -40 to 125   | LC02A                                    | Samples |
| SN74LVC02ARGYR   | ACTIVE | VQFN         | RGY     | 14   | 3000 | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-2-260C-1 YEAR | -40 to 125   | LC02A                                    | Samples |
| SNJ54LVC02AFK    | ACTIVE | LCCC         | FK      | 20   | 1    | TBD                        | POST-PLATE       | N / A for Pkg Type  | -55 to 125   | 5962-<br>9760401Q2A<br>SNJ54LVC          | Samples |



6-Feb-2020

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking                      | Samples |
|------------------|--------|--------------|---------|------|---------|----------|------------------|--------------------|--------------|-------------------------------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)      | (6)              | (3)                |              | (4/5)                               |         |
|                  |        |              |         |      |         |          |                  |                    |              | 02AFK                               |         |
| SNJ54LVC02AJ     | ACTIVE | CDIP         | J       | 14   | 1       | TBD      | Call TI          | N / A for Pkg Type | -55 to 125   | 5962-9760401QC<br>A<br>SNJ54LVC02AJ | Samples |
| SNJ54LVC02AW     | ACTIVE | CFP          | W       | 14   | 1       | TBD      | Call TI          | N / A for Pkg Type | -55 to 125   | 5962-9760401QD<br>A<br>SNJ54LVC02AW | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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6-Feb-2020

#### OTHER QUALIFIED VERSIONS OF SN54LVC02A, SN74LVC02A :

- Catalog: SN74LVC02A
- Automotive: SN74LVC02A-Q1, SN74LVC02A-Q1
- Enhanced Product: SN74LVC02A-EP, SN74LVC02A-EP
- Military: SN54LVC02A

#### NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications
- Military QML certified for Military and Defense Applications

# PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

### TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device         | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|----------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74LVC02ADR   | SOIC            | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LVC02ANSR  | SO              | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LVC02APWR  | TSSOP           | PW                 | 14 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LVC02APWT  | TSSOP           | PW                 | 14 | 250  | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |
| SN74LVC02ARGYR | VQFN            | RGY                | 14 | 3000 | 330.0                    | 12.4                     | 3.75       | 3.75       | 1.15       | 8.0        | 12.0      | Q1               |

TEXAS INSTRUMENTS

www.ti.com

# PACKAGE MATERIALS INFORMATION

20-Dec-2018



\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC02ADR   | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74LVC02ANSR  | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LVC02APWR  | TSSOP        | PW              | 14   | 2000 | 367.0       | 367.0      | 35.0        |
| SN74LVC02APWT  | TSSOP        | PW              | 14   | 250  | 367.0       | 367.0      | 35.0        |
| SN74LVC02ARGYR | VQFN         | RGY             | 14   | 3000 | 367.0       | 367.0      | 35.0        |

LEADLESS CERAMIC CHIP CARRIER

FK (S-CQCC-N\*\*) 28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



# **MECHANICAL DATA**



- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- earrow Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated.
- The Pin 1 identifiers are either a molded, marked, or metal feature.
- G. Package complies to JEDEC MO-241 variation BA.



# RGY (S-PVQFN-N14)

## PLASTIC QUAD FLATPACK NO-LEAD

#### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.



#### NOTE: All linear dimensions are in millimeters





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.

D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <a href="http://www.ti.com">http://www.ti.com</a>.

- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



# J0014A

# **EXAMPLE BOARD LAYOUT**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

### DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



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